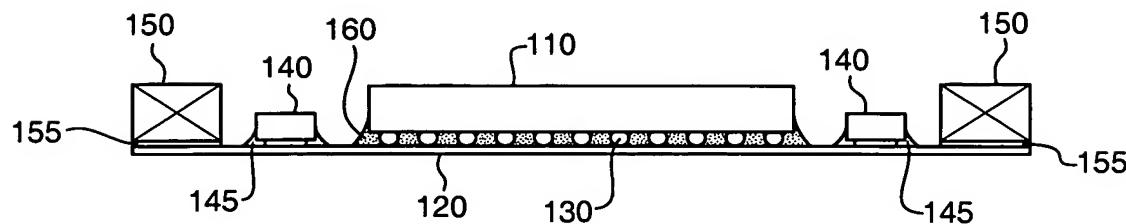




Title: "Molded Flip Chip Package"

Inventors: Kumamoto et al. Application No.: 10/051,980 Attorney Docket No.: 42390P9482D  
Blakely, Sokoloff, Taylor & Zafman 303-740-1980

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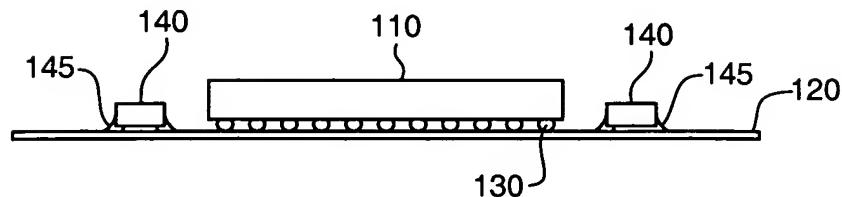


**FIG. 1**  
**PRIOR ART**

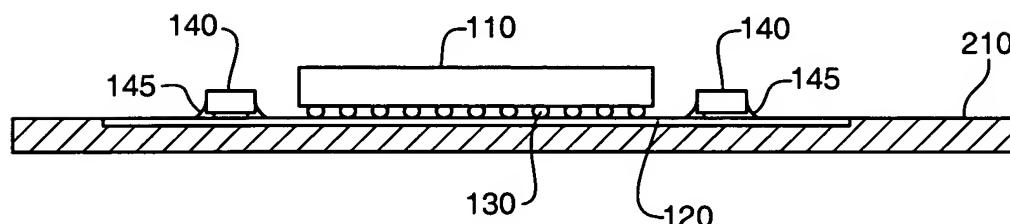
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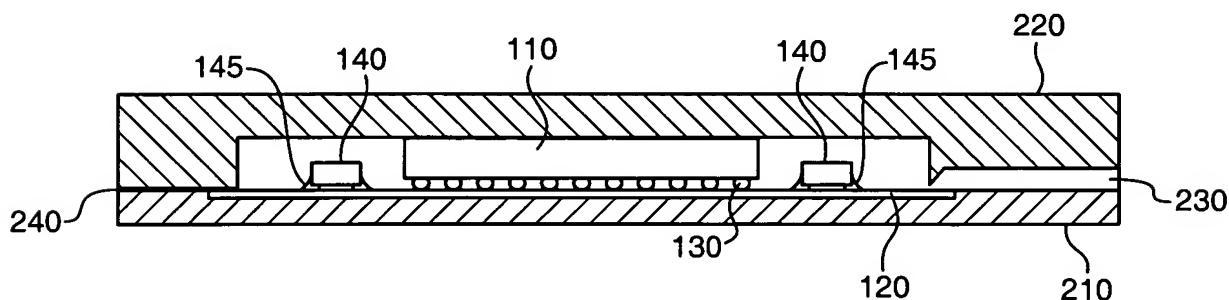
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**FIG. 2A**



**FIG. 2B**

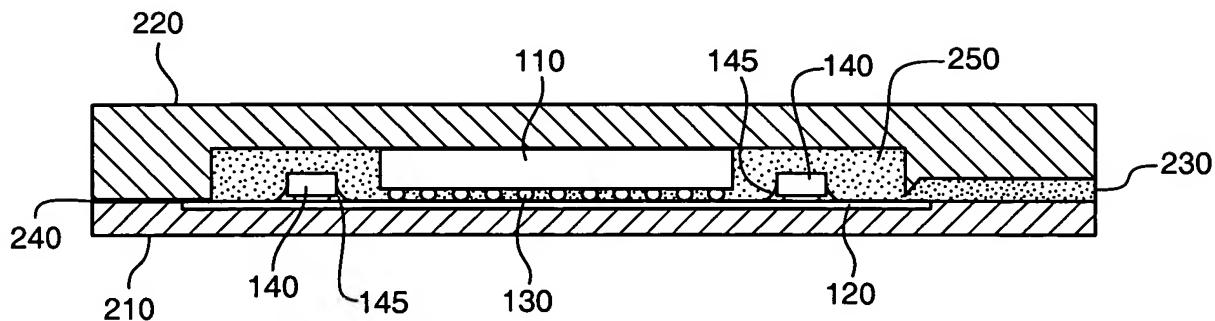


**FIG. 2C**

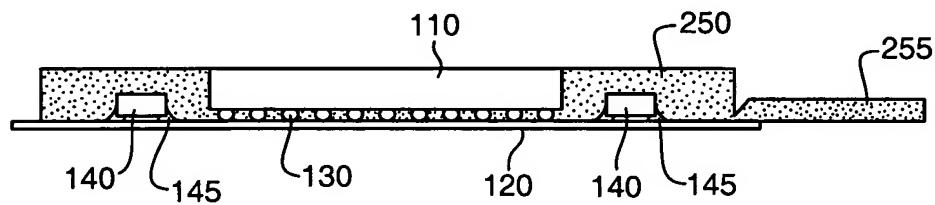
OCT 06 2003  
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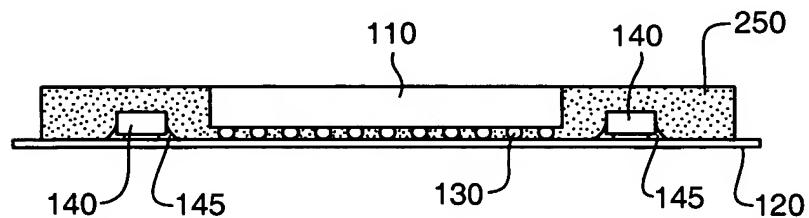
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**FIG. 2D**



**FIG. 2E**



**FIG. 2F**



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**FIG. 3**

